DECLARATION FOR NON-PROVISIONAL PATENT APPLICATION'

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below at 201 et seq. beneath my name.

I believe I am the original, first and sole inventor if only one name is listed at 201 below, or an original, first and joint inventor if plural names are listed at 201 et seq: below, of the subject matter which is claimed and for which a patent is sought on the invention entitled

| and for which a patent application: is attached hereto and include: was filed in the United States with amendment(s) filed on (a was filed as PCT international I hereby state that I have reviewed a amendment referred to above I acknowledge the duty to disclose it Regulations, § 1.56. I hereby claim foreign priority beneficiate listed below and have also of the application on which priority | on as Application No. (for dec Fuplication No. on and we and understand the contents of information known to me to be fits under Title 35, United State to identified below any foreign | thration not secompanying applicates as amended under PCT Af the above identified apple material to patentability the Code, §119(a)-(d) of | rticle 19 on (Yeppies) lication, including to y as defined in Title any foreign applics | the claims, as amore 37, Code of Feder stion(s) for patent o | rai or inventor's | |
|---|--|--|--|--|-------------------------------|--|
| EARLIEST FOREIGN | APPLICATION(S), IF ANY | FILED PRIOR TO THE | S FILING DATE O | P THE APPLICAT | MON | |
| APPLICATION NUMBER | COUNTRY | | OF FILING onth, year) | PRIORITY | CLAIMED | |
| | | | | YES 🗆 | № □ | |
| | | | | YES 🗆 | № 🗆 | |
| I hereby claim the benefit under The | ICATION NUMBER | 19(a) of any United State | | pation(s) listed belo |)w. | |
| 60/41 | September 16, 2002 | | | | | |
| | | | | | | |
| I hereby claim the benefit under Tit matter of each of the claims of this paragraph of Title 35, United States as defined in Title 37, Code of Feder national or PCT international filing | application is not disclosed in Code §112, I acknowledge ti ral Regulations, §1.56 which | the prior United States to he duty to disclose infor | application in the matter known to me | anner provided by which is material | the first to patentability | |
| NON-PROVISIONAL | filing date | STATUS | | | | |
| APPLICATION SERIAL NO. | | PATENTED | PENDIN | G A | BANDONED | |
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for use only when the application is assigned to a company, partnership or other organization.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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